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(54) **Reflection mode alkali photocathode, and photomultiplier using the same.**

(57) This invention relates to an improvement of a reflection mode alkali photocathode which relies on controlling a deposition weight of antimony. The reflection mode alkali photocathode according to this invention includes a thin layer of antimony directly deposited on a base substrate and activated by

alkali metals. The thin film of antimony is deposited in a thickness of below 100 $\mu\text{g}/\text{cm}^2$. This reflection mode photocathode is suitably usable in photomultipliers. As the base substrate, nickel, aluminium and stainless, etc. are used. As the alkali metals, cesium, potassium, sodium and rubidium are usable.

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This invention relates to a reflection mode alkali (bialkali or multialkali) photocathode, and a photomultiplier using the same.

In conventional photocathode, there are a transmission mode photocathode which emits electrons to the side opposite to a side of light incidence, i.e., converts incident photons into photoelectron and transmits the photoelectron, and the reflection mode photocathode which emits photoelectron to the side of light incidence, i.e., converts incident photons into photoelectron and emits the photoelectron back to the side of light incidence. The reflection mode photocathode comprises the base substrate mainly of a metal. The reflection mode bialkali photocathode and reflection mode multialkali photocathode having the base substrates of nickel (Ni) are known. In the reflection mode bialkali photocathode, antimony (Sb) is deposited on a Ni base substrate and is activated by alkali metals of potassium (K) and cesium (Cs). In the multialkali photocathode surface as well, Sb is deposited on a Ni base substrate and is activated by K, Cs and sodium (Na). The Sb deposition amount has been generally above 200 $\mu\text{g}/\text{cm}^2$ as will be explained later.

In the above-mentioned conventional reflection mode alkali photocathode, e.g., bialkali photocathode, their radiant sensitivity is about $S_k = 80 \mu\text{A}/\text{Lm}$. Even in a reflection mode bialkali photocathode having an intermediate layer between the Sb layer and the base substrate, its radiant sensitivity is $S_k = 120 \mu\text{A}/\text{Lm}$ at maximum. Here $\mu\text{A}/\text{Lm}$ represents a sensitivity in the unit of lumen. Lumen is a unit of luminous flux based on the visual sensitivity, and $1 \text{ Lm}/\text{m}^2 = 1 \text{ Lux}$. The radiant sensitivity S_k corresponds to a current density of the photocathode given when an intensity of incident light is expressed by Watts.

The photomultiplier is used in the field of measuring feeble light. Properties of the photomultiplier is exhibited in the limit region where light to be detected is counted in photons. Accordingly even some percentage of sensitivity improvement is significant.

From this viewpoint, we, the inventors, made studies, and find that a good reflection mode alkali photocathode can be realized by controlling a deposition weight of Sb.

The reflection mode alkali photocathode according to this invention comprises a thin layer of antimony deposited on a base substrate, and activated by a plurality of kinds of alkali metals, in which the thin layer of antimony being deposited in an amount below 100 $\mu\text{g}/\text{cm}^2$ and activated by the alkali metals. The reflection mode alkali photocathode according to this invention is suitably usable in photomultipliers.

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In the reflection mode alkali photocathode according to this invention, the thin layer of Sb activated by the alkali metals is deposited sufficiently thin. This is a drastic change of a conventional idea involved in the conventional reflection mode photocathode. That is, a reduction of a 200 $\mu\text{g}/\text{cm}^2$ deposition amount of the conventional Sb layer of the conventional reflection mode photocathode $\mu\text{g}/\text{cm}^2$ to below 100 $\mu\text{g}/\text{cm}^2$ can produce sufficiently satisfactory results.

To improve photosensitivities of the photocathode including Sb, the selection of materials of the base substrate of the photocathode surface, the improvement of the surface treatment of the photocathode, and the fabrication conditions, such as temperatures and degrees of vacuum for activating the photocathode surface with alkali metals are tried.

But we, the inventors, notice the deposition weight of Sb which is means completely different from the above-mentioned means, and made studies on it. We, the inventors believe that nobody has studied this means nor published results of his studies. Our finding is that photosensitivities of the photocathode is very dependent on deposition weights of Sb. First, they analyze by an electron balance the deposition weights of the Sb of photomultipliers (hereinafter called "PMT") marketed by Hamamatsu Photonics K.K. The results of their analyses show that the deposition weights of the reflection mode photocathode of both multialkali and bialkali types are about 200 $\mu\text{g}/\text{cm}^2$.

Then, we, the inventors, fabricated for tests PMTs having various Sb deposition weights and studied the deposition weight dependency of the radiant sensitivity. Our finding is that the photocathode of these PMTs have peak photosensitivities at about 40 $\mu\text{g}/\text{cm}^2$ and are superior to the conventional photocathode.

That is, we have experimentally proved that sufficient radiant sensitivities can be obtained in a Sb deposition weight range of 10 $\mu\text{g}/\text{cm}^2$ - 100 $\mu\text{g}/\text{cm}^2$. As for radiant sensitivities at below 10 $\mu\text{g}/\text{cm}^2$, we find out, by extrapolating data of the experiments, that radiant sensitivities of the fabricated PMTs more than that of the conventional PMTs can be obtained at, e.g., even some $\mu\text{g}/\text{cm}^2$. Especially in the case the base substrate of a photocathode surface is formed of aluminium (Al), high photosensitivities can be obtained even in a range of 5 $\mu\text{g}/\text{cm}^2$ - 10 $\mu\text{g}/\text{cm}^2$.

The Sb deposition weights were quantitatively determined by the following method.

Antimony (Sb) can be deposited on a nickel plate functioning as the base substrate by, e.g., the following method. First, a target made of Sb is placed on a heater as the evaporation source in a vacuum vessel. Eight sheets of nickel plates are

set respectively at the same distance from the evaporation source. Then, the heater is turned on to vaporize the Sb. Then based on a vaporizing amount of the Sb from the heater and a distance from the evaporation source to the nickel plates, a deposition weight of the Sb per a unit area can be easily given.

The evaporation of the Sb is not always uniform in all the directions, and the evaporation of all the Sb is not secured. Accordingly it is difficult to measure an accurate deposition weight by the above-described indirect method. Then, to improve the reliability of the tests, we, the inventors, used the following direct method.

A evaporation source including a wire heater 101 and Sb target adhered to the wire heater 101 in a uniform thickness was prepared. The wire heater 101 was set vertical as shown in FIG. 1. Eight nickel plates 201 - 208 were set upright on a evaporation ring 102 which was rotatable around the wire heater 101. The respective nickel plates 201 - 208 were positioned at the same distance from the wire heater 101. A direct current was supplied to the wire heater 101 through electrodes 103, 104 with the evaporation ring 102 set on rotation, so that the Sb was slowly evaporated. Thus the Sb could be deposited evenly on all the nickel plates 201 - 208.

A deposition weight of the Sb was measured as follows. Weights of the 8 sheets of nickel plates before the deposition were measured by an electron balance type measurement device of high precision with the zero point adjusted. Then the Sb was evaporated by the method of FIG. 1. A deposition weight could be controlled with high precision by adjusting a deposition amount of the solid Sb to the wire heater, and also by adjusting evaporation times or heating temperatures with the wire heater with the same adhesion amount. Then the 8 nickel plates with the Sb adhered to were measured by the electron balance type measurement device with the zero point adjusted.

A deposition weight of the Sb per a unit area could be determined based on differences of weights of the measured nickel plates between before and after the deposition, and deposition areas of the nickel plates. The data of FIGs. 2, 3 and 4 were thus obtained.

It is preferred that the base substrate, which is in direct contact with the Sb thin layer, is formed of, e.g., Ni, Al or stainless steel. K, Ca, Rb and Na are suitable as the alkali metals. Thus a reflection mode alkali photocathode of high radiant sensitivity can be realized with high yields.

The present invention will become more fully understood from the detailed description given hereinbelow and the accompanying drawings which are given by way of illustration only, and thus are

not to be considered as limiting the present invention.

Further scope of applicability of the present invention will become apparent from the detailed description given hereinafter. However, it should be understood that the detailed description and specific examples, while indicating preferred embodiments of the invention, are given by way of illustration only, since various changes and modifications within the spirit and scope of the invention will become apparent to those skilled in the art from this detailed description.

FIG. 1 is a view of the device for evaporating Sb used by the inventors of this invention for high precision of measuring the deposition weights of the Sb.

FIG. 2 is a graph of the radiant sensitivity characteristic of one alkali photocathode fabricated for the tests.

FIG. 3 is a graph of the radiant sensitivity characteristic of another alkali photocathode fabricated for the tests.

FIG. 4 is a graph of the radiant sensitivity characteristic of one of the multialkali photocathode surfaces fabricated for the tests.

FIG. 5 is a side view of a side-on PMT with the glass bulb partially broken.

FIG. 6 is a sectional view of the PMT of FIG. 5 along the line $X_1 - X_2$.

This invention will be explained below in more detail. The reflection mode alkali photocathode according to this invention comprises a base substrate of Ni or others, and a photosensitive layer containing Sb activated by alkali metals, such as cesium (Cs), potassium (K), sodium (Na) and rubidium (Rb). A deposition weight of the Sb is below $100 \mu\text{g}/\text{cm}^2$.

A photomultiplier having such reflection mode alkali photocathode is fabricated as follows. A glass vacuum vessel is prepared, and Sb is evaporated on a part for the reflection mode photocathode to be formed on. Sb is deposited as a thin film in deposition weight of a below $100 \mu\text{g}/\text{cm}^2$, or a porous film. Subsequently when in the photocathode surface portion made of a alkali, Cs, Na, K are introduced to activate the photocathode surface portion, and the photocathode is sintered. Temperature conditions and times for the activation and the sintering are set suitably as known. Incidentally a temperature is selected from $140 - 220^\circ\text{C}$.

The other members of a photomultiplier (PMT), such as dynodes, microchannel plates, an anode, etc. are mounted in the conventional procedure. When the reflection mode alkali photocathode is formed, and the members are mounted, the vacuum vessel is closed, and the reflection mode alkali photocathode is finished.

A structure of a photomultiplier having the reflection mode alkali photocathode according to this invention is shown in FIGs. 5 and 6. As shown in FIG. 5, a glass bulb 2 is mounted on a support 1, and stem pins 3A - 3F are provided downwardly on the support 1. As in the sectional view along the line $X_1 - X_2$ of FIG. 5, the glass bulb 2 houses a cathode 4 of a nickel base substrate with a photocathode surface formed on, a metal mesh electrode 5 provided on the front surface of the glass bulb 2, a circular cage-type 9-stage dynodes 61 - 69, and an anode 7. In this PMT light passing the metal mesh electrode 5 enters the cathode 4. Photoelectron thus emitted impinge on the respective dynodes 61, 62, ..., ..., 68, 69 one after another, and a number of the electrons is rapidly increased by the emission of secondary electrons. Then all the electrons are collected by the anode 7 and are taken outside as electric signals through one of the stem pins 3A - 3F.

Next, examples of fabrication for tests of the bialkali photocathode surface will be explained. In all the examples the conditions, such as temperatures, vacuum degrees, times, etc. are the same irrespective of deposition weights of Sb. In the examples, base substrates were Ni plates having the surfaces (weakly) oxidized, and Sb layers were formed on the rinsed oxidized surfaces.

In the examples, the Sb layers were deposited in 6 different thicknesses (deposition weights) from 15 - 230 $\mu\text{g}/\text{cm}^2$. Then K, Cs were introduced to activate the Sb layers to obtain a bialkali (K-Cs-Sb) photocathode. Twenty photocathode surfaces (totally 120) were prepared at the respective set deposition weights.

The sample photocathode surfaces exhibited the radiant sensitivity characteristic of FIG. 2. An average luminous sensitivity is below about 80- ($\mu\text{A}/1\text{m}$) at a deposition weight of Sb of above 100 $\mu\text{g}/\text{cm}^2$. At a deposition weight of 20 - 80 $\mu\text{g}/\text{cm}^2$, an average luminous sensitivity is above 115 ($\mu\text{A}/1\text{m}$).

As apparent in FIG. 2, the deposition of Sb in 40 $\mu\text{g}/\text{cm}^2$ provides especially much improvement of the radiant sensitivity. The sample photocathode surfaces exhibited a maximum value of 193 $\mu\text{A}/1\text{m}$. A 150 $\mu\text{A}/1\text{m}$ radiant sensitivity could be stably realized. This high sensitivity widely ranged from the near infrared radiation to the ultraviolet radiation.

Furthermore, the inventors fabricated for test bialkali photocathode surfaces, using nickel, stainless steel and aluminium as the base substrates, and potassium, cesium, rubidium, etc. as the alkali metals.

Sample A: A nickel plate having the surface weakly oxidized was used, and K-Cs was used as the alkali metals.

Sample B: A nickel plate having the surface non-oxidized, and K-Cs was used as the alkali metals.

Sample C: A nickel plate having the surface oxidized, and Rb-Cs was used as the alkali metals.

Sample D: A stainless steel (non-magnetic material) plate which has undergone no oxidizing step, and K-Cs was used as the alkali metals.

Sample E: An aluminium plate which has undergone no oxidizing step, and K-Cs was used as the alkali metals.

Five PMTs were prepared for each of 10, 20, 50, 80 and 160 $\mu\text{g}/\text{cm}^2$ Sb deposition weights of each of Samples A, B, D and E. Three PMTs were prepared for each of the above-stated Sb deposition weights for Sample C. Average radiant sensitivities were determined.

The results are shown in FIG. 3. As shown in FIG. 3, in the cases that the base substrates are formed of nickel and stainless steel, high radiant sensitivities can be obtained at an Sb deposition weight of 10 - 100 $\mu\text{g}/\text{cm}^2$. In the case that the base substrate is formed of aluminium, a high sensitivity can be obtained at 5 - 100 $\mu\text{g}/\text{cm}^2$.

Then samples of the multialkali photocathode surface will be explained. In the samples, the base substrates were Al plates having Al deposited on the surfaces, and Sb layers were deposited on the rinsed surfaces of the Al plates.

In the examples, the Sb layers were deposited in 7 different thicknesses (deposition weights) from 15 - 205 $\mu\text{g}/\text{cm}^2$. Then Na, K, Cs were introduced into to activate the Sb layers to obtain a multialkali (Cs-Na-K-Sb) photocathode. Five photocathode (totally 35) were prepared at the respective set deposition weights.

The sample photocathode surfaces exhibited the radiant sensitivity characteristic of FIG. 4. An average luminous sensitivity is below about 120 ($\mu\text{A}/1\text{m}$) at a deposition weight of Sb of above 100 $\mu\text{g}/\text{cm}^2$. At a deposition weight of 20 - 80 $\mu\text{g}/\text{cm}^2$, an average luminous sensitivity is above 140 - 150 ($\mu\text{A}/1\text{m}$).

As apparent in FIG. 4, the deposition weight of Sb in about 40 $\mu\text{g}/\text{cm}^2$ can attain especially much improvement of the radiant sensitivities. In the samples, radiant sensitivities of about 200 $\mu\text{A}/1\text{m}$ can be stably realized. The high radiant sensitivities widely range from the near infrared radiation to the ultraviolet radiation. It is apparent from the examples and the test results that base substrates of nickel, stainless, aluminium or others can be used in the multialkali photocathode surface.

The alkali photocathode according to this invention includes the Sb layer in the deposition weight of below 100 $\mu\text{g}/\text{cm}^2$, whereby reflection mode alkali photocathode of a high sensitivity can be realized with high yields. As alkali metals used in

the photocathode surface according to this invention, some elements other than cesium, potassium, rubidium and sodium are available. As the base substrate of the photocathode surface according to this invention, some metals other than aluminium, nickel and stainless are available. Although the inventors have not obtained experimental data on all combinations of these materials, the results of their experiments on combinations of typical materials showed characteristics common to the experiments, i.e., the Sb deposition weight dependency of the radiant sensitivity as shown in FIGs. 1 - 3.

Accordingly the photocathodes which are formed of not only the experimentally proved materials, but also of materials equivalent to these materials, and which have Sb deposition weights of below $100 \mu\text{g}/\text{cm}^2$ are included in the coverage of this invention.

From the invention thus described, it will be obvious that the invention may be varied in many ways. Such variations are not to be regarded as a departure from the spirit and scope of the invention, and all such modifications as would be obvious to one skilled in the art are intended to be included within the scope of the following claims.

Claims

1. A reflection mode alkali photocathode comprising
 - a base substrate; and
 - a layer containing antimony and a plurality of alkali metals formed on a base substrate, the antimony forming with a deposition weight of below $100 \mu\text{g}/\text{cm}^2$ on said substrate.
2. A reflection mode alkali photocathode according to claim 1, wherein the base substrate is formed of nickel or stainless steel, and the a deposition weight of the antimony is above $10 \mu\text{g}/\text{cm}^2$.
3. A reflection mode alkali photocathode according to claim 1, wherein the base substrate is formed of nickel or stainless steel, and the a deposition weight of the antimony is above $5 \mu\text{g}/\text{cm}^2$.
4. A reflection mode alkali photocathode according to claim 1, wherein at least one of the plural kinds of alkali metals is sodium, potassium, rubidium, and cesium.
5. A photomultiplier comprising;
 - a reflection mode alkali photocathode unit including a base substrate, and a layer containing antimony and a plurality of alkali metals

on said substrate, wherein the antimony is formed with a deposition weight of below $100 \mu\text{g}/\text{cm}^2$ on said base substrate;

electron multiplying means for multiplying photoelectron emitted from the reflection mode alkali photocathode; and

an anode for multiplied electrons to enter.

Fig. 1

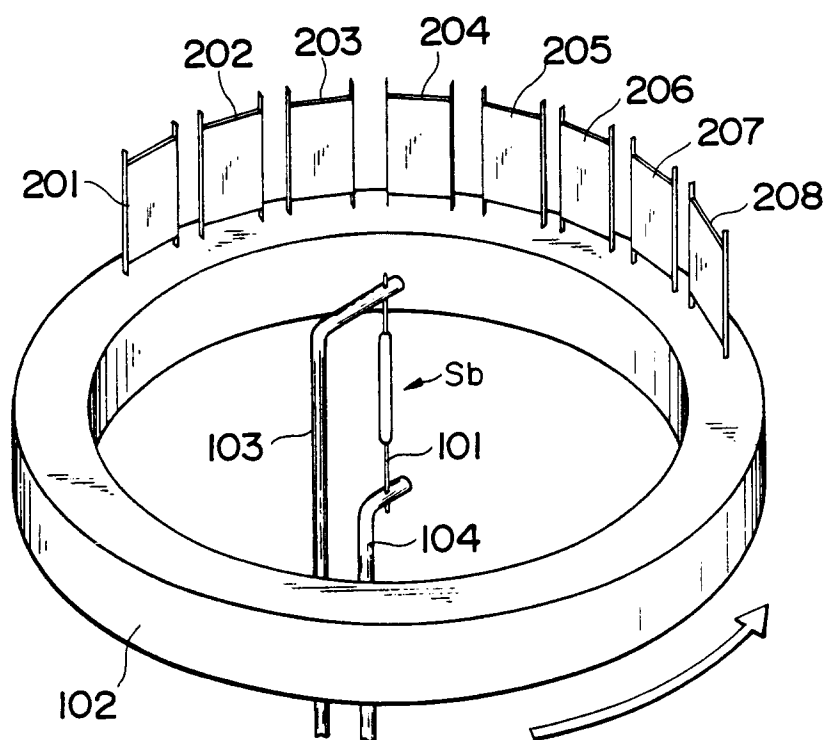


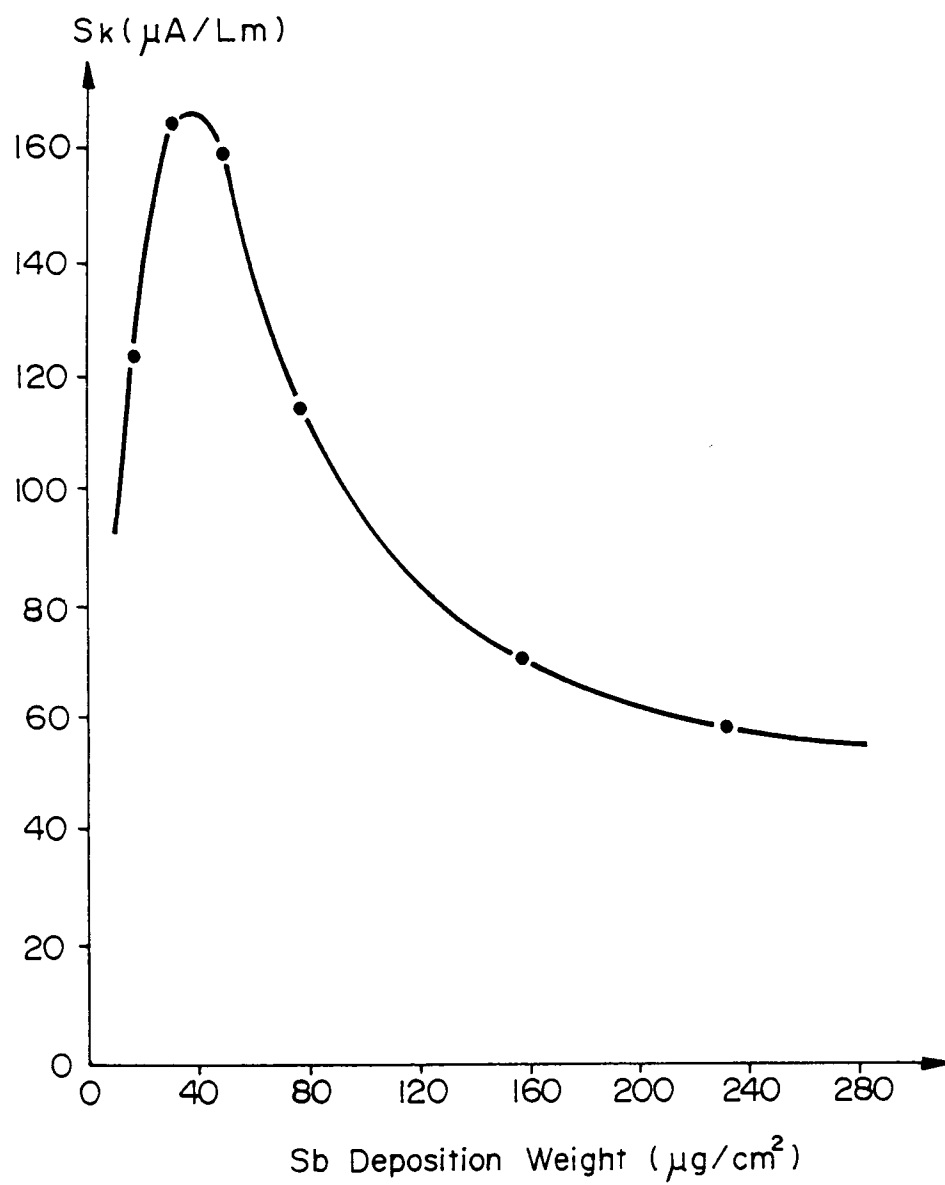
Fig.2

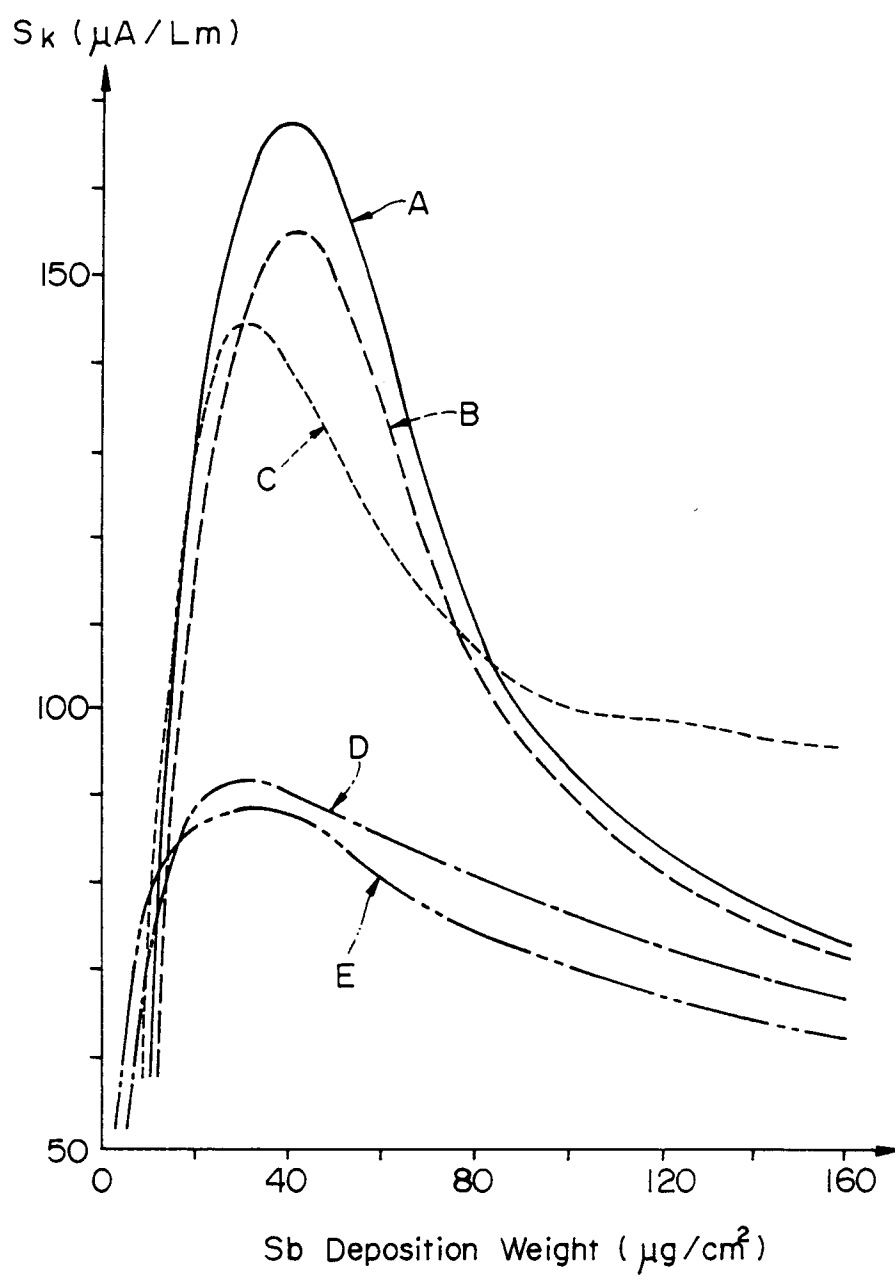
Fig. 3

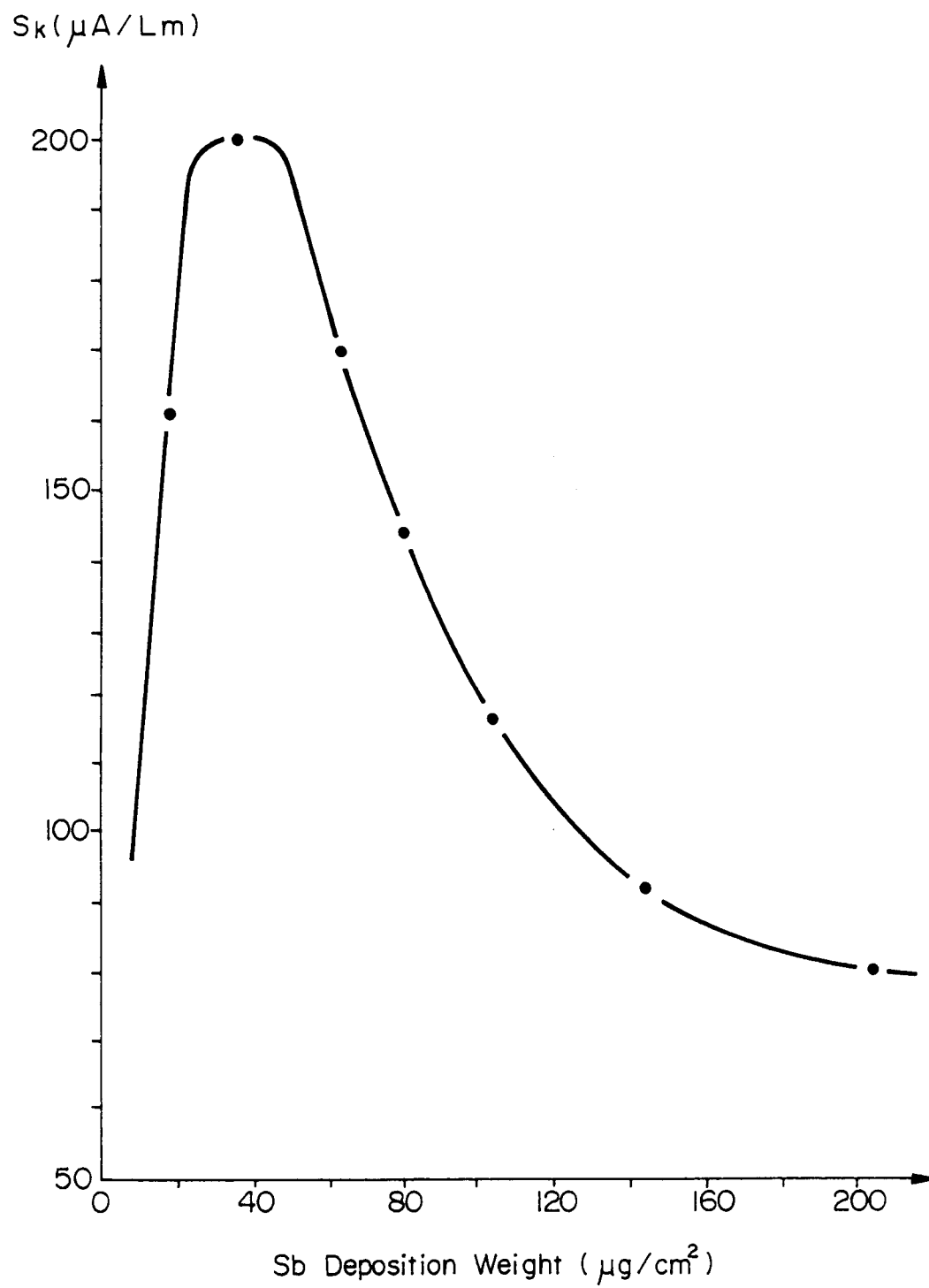
Fig. 4

Fig. 6

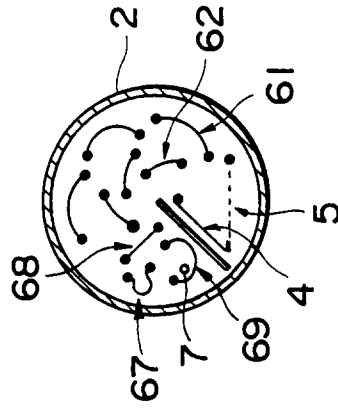
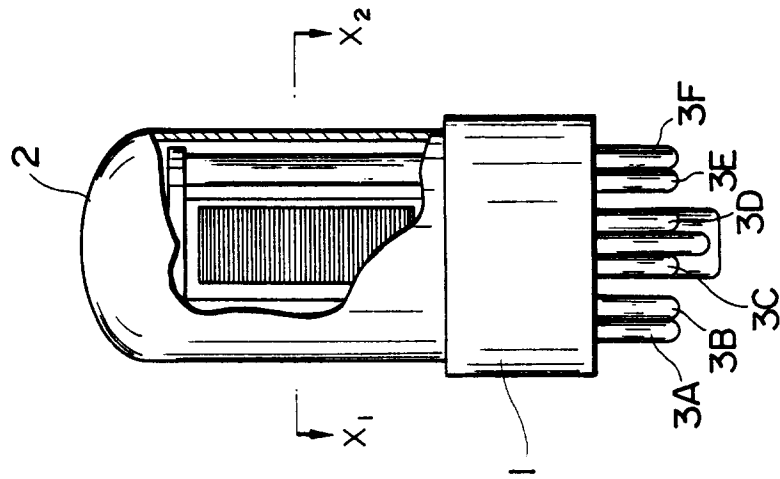


Fig. 5





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EUROPEAN SEARCH REPORT

Application Number
EP 93 30 7128

DOCUMENTS CONSIDERED TO BE RELEVANT			
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int.Cl.5)
X	EP-A-0 532 358 (HAMAMATSU PHOTONICS K.K.) * column 1, line 33 - line 50 * * column 2, line 20 - line 43 * * column 3, line 54 - column 4, line 2 * ---	1-5	H01J1/34 H01J43/08
E	EP-A-0 567 297 (HAMAMATSU PHOTONICS K.K.) * column 2, line 2 - line 13 * * column 2, line 48 - column 3, line 9 * * claims 3,11 * ---	1-5	
X	PHILIPS TECHNICAL REVIEW, vol.40, no.1, 1982, EINDHOVEN NL pages 19 - 28 P DOLIZY 'Growth of alkali-antimonide films for photocathodes' * page 21, right column, paragraph 2 * * figure 10 * ---	1	
A	US-A-4 341 427 (TOMASETTI ET AL.) * column 2, line 42 - line 54 * -----	1	
			TECHNICAL FIELDS SEARCHED (Int.Cl.5)
			H01J
The present search report has been drawn up for all claims			
Place of search THE HAGUE		Date of completion of the search 6 September 1994	Examiner Colvin, G
CATEGORY OF CITED DOCUMENTS X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons & : member of the same patent family, corresponding document			